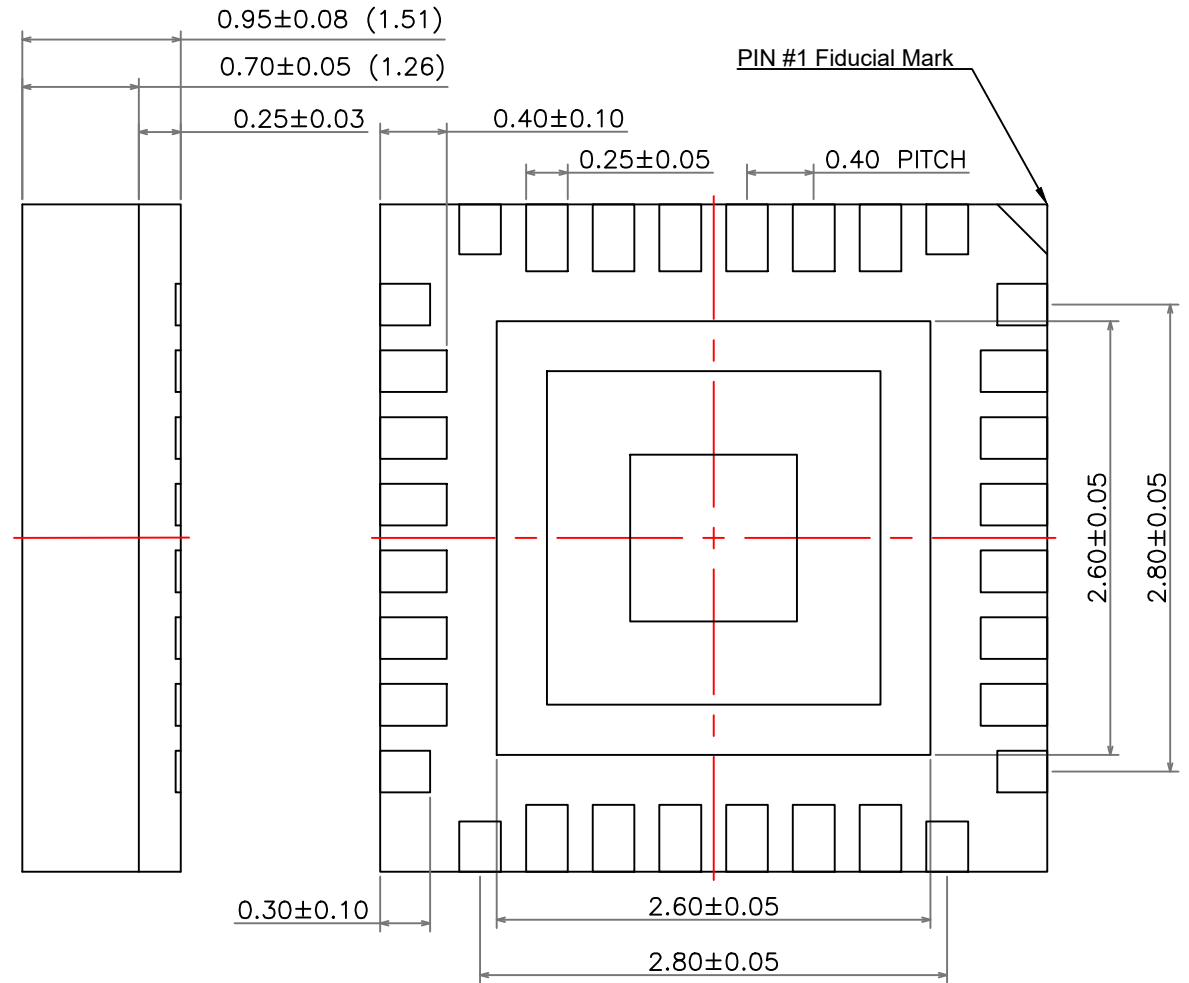


TOP VIEW



SIDE VIEW

BOTTOM VIEW

NOTES :

1. DRAWING CONFORM TO JEDEC
2. ALL DIMENSIONS ARE IN MILLIMETERS
3. SOLDERABLE EXPOSED PAD : 2.60 X 2.60 MM
4. DIMENSIONING AND TOLERANCING PER JEDEC
5. DIVERSIFICATION OF THE PKG OUTLINE IS POSSIBLE AS A LAND RADIAL TYPE

DESIGNED BY	CHECKED BY	CHECK BY	APPROVED BY	TITLE		
K.S.YUN				<b>PKG OUTLINE DIMENSION MLQFN 32LD 4x4mm</b>		
10/01/2023				UNIT	TOLERANCE	SCALE
<b>SNPT</b> (Semiconductor And Packaging Testing Corporation)				MM	-	1:1
				DWG NO.	SPEC NO.	SHEET
				POD-MLQFN-0432	MLQFN-09	1 OF 1